

*Paragon Semiconductor Lighting Technology*

*PSLT*

**ParagonLED**

## Specifications

**Product Type : CGAC-008-30135-120V-30**

**Issued Date : 12/01/2012**

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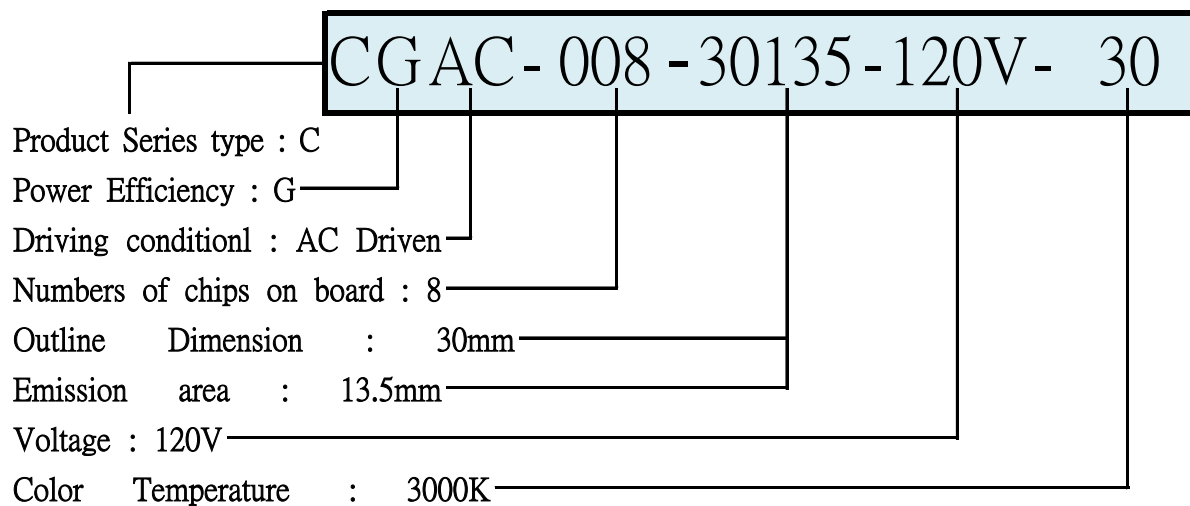
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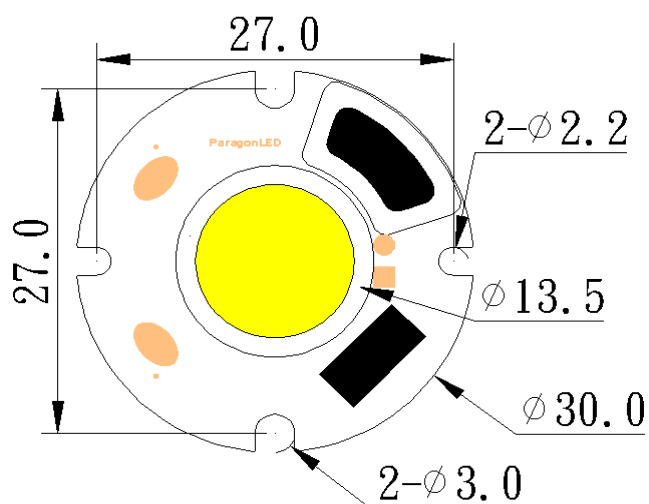
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## 1. General Description

### (1) Naming rule



### (2) Outline Dimensions (Unit : mm / Tolerance: 0.2mm)



Thickness :  $1.0 \pm 0.1$ mm

## 2. Electro-Optical Characteristics

### (1) Absolute Maximum Rating

Parameter	Symbol	Value	Unit
Power Dissipation	PD	6	W
Forward Current	IF	-	mA
Forward Voltage	VF	100 ~ 130	V
Operating Temperature	Topr	-40 ~ +60	°C
Storage Temperature	Tstg	-40 ~ +80	°C
Assembly process temperature	Tsol	<300°C , 5 secs	

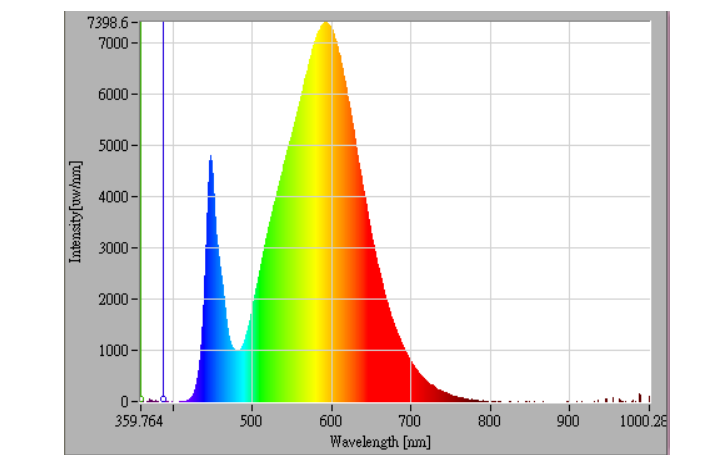
## (2) Electro-Optical Characteristics

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage	VF	–	100	120	130	V
Reverse Current	IR	–	–	–	–	$\mu A$
Luminous Intensity	$\Phi_v$	VF=120V	–	420	–	Lm
Color rendering	Ra	VF=120V	–	80	–	

**Notice: Operating voltage of CGAC-008 product varies from 110V~140V · users must keep the temperature of solder joint point under 90°C (with suitable heat sink), or may cause Serious luminous decay. We DO NOT guarantee of improper use.**

## (3) Characteristics

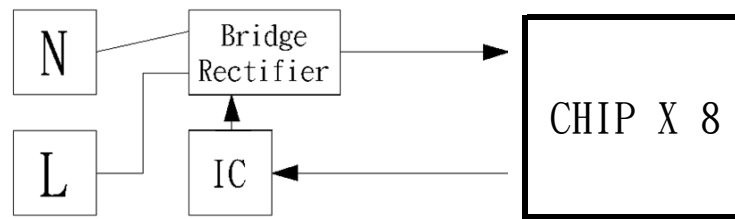
### Spectrum



### Candle Power Distribution & Cartesian Coordinate

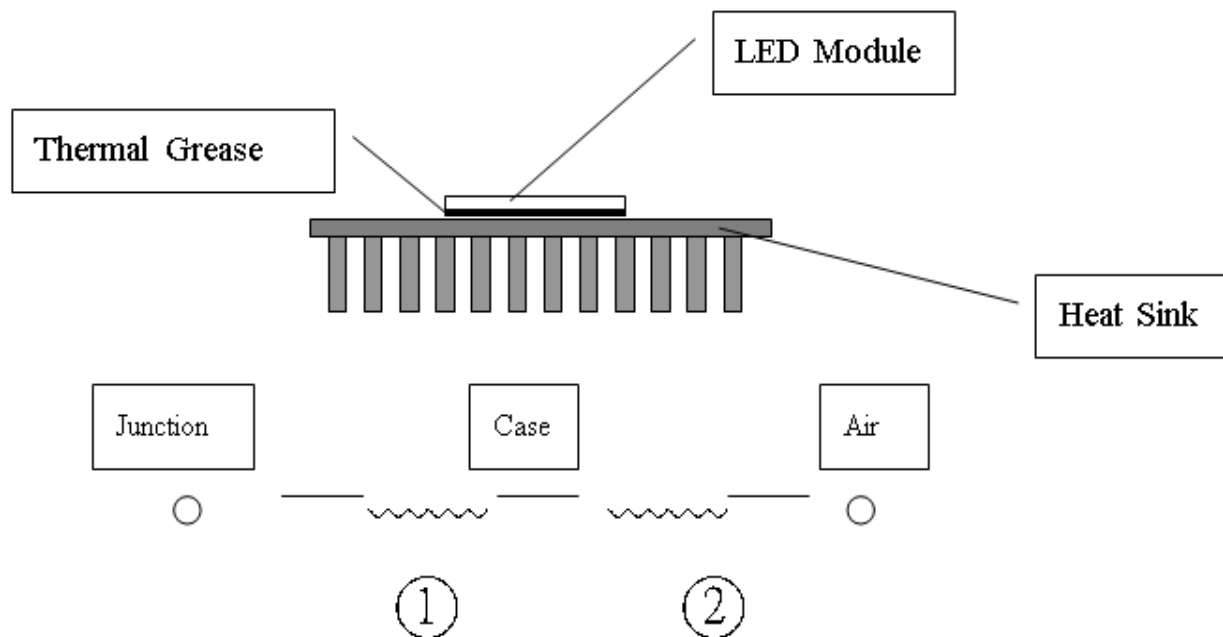


#### (4) Layout



2 series x 4 parallel = 8 LED Chips

### 3. Junction Temperature Measurement



① Thermal resistance of Junction to Case without heat sink :  $10(^{\circ}\text{C}/\text{W})$  [ Reference Value ]

② Thermal resistance of Case to Ambient Air: Depending on what kind of heat sink users choose. In ideal thermal dissipation situation, the thermal resistance is about  $1\sim 2^{\circ}\text{C}/\text{W}$ .

## 4. Reliability Test

Test Item	Test Conditions	Number of failed
High Temperature Storage Test	Tstg= +80°C , x1,000 hrs	0/20
Low Temperature Storage Test	Tstg=-40°C , x1,000 hrs	0/20
Continuous Light-on Test	Ta= 25°C , RH=65% , x1,00 hrs	0/20
Boiling Test	Ta=100°C , RH=100% , X180mins	0/20
Thermal Cycle Test	- 40°Cx30mins , 80°Cx30mins , 100cycles	0/20

Measuring Item	Measuring Condition	Judging Criteria of Failure
Forward Voltage	VF=120V	> 0 x 1.1
Total Luminous Flux	VF=120V	< L x 0.7